

As the below named inventor, I hereby declare that:

the specification of which

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

CIRCUIT TRIMMING OF PACKAGED IC CHIP

<u>X</u>					
	was filed on as Application Seri	al No	and was amended on		<u> </u>
apr apr apr	ecification, including the lacknowledge the olication in accordance I hereby claim fore olication(s) for patent	he claims, as amended e duty to disclose info e with Title 37, Code of ign priority benefits un or inventor's certificate inventor's certificate ha	and understand the content of by any amendment referred rmation which is material to of Federal Regulations, § 1.5 der Title 35, Untied States C elisted below and have also id aving a filing date before that	I to above. the patenta 6(a). ode, § 119 dentified belo	ability of this of any foreign ow any foreign
	Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
	90121109	Taiwan, R.O.C.	2001/8/28	X	
	I hereby appoint the following attorney(s transact all business in the Patent and Tradem Jiawei Huang (Reg. No. 43,330 Maria Erlinda C. Sarno (Reg. No. 37,430 Belinda Lee (Reg. No. 46,860		oark Office connected therewing (a) Charles C.H. Wu Chanette Armstrong		
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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